

# STL7LN80K5

### N-channel 800 V, 0.95 Ω typ., 5 A MDmesh<sup>™</sup> K5 Power MOSFET in a PowerFLAT<sup>™</sup> 5x6 VHV package

Datasheet - production data

### Features

Order code	VDS	R <sub>DS(on)</sub> max.	ID
STL7LN80K5	800 V	1.15 Ω	5 A

- Industry's lowest R<sub>DS(on)</sub> x area
- Industry's best FoM (figure of merit)
- Ultra-low gate charge
- 100% avalanche tested
- Zener-protected

### **Applications**

• Switching applications

### Description

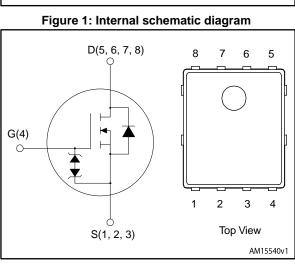
This very high voltage N-channel Power MOSFET is designed using MDmesh<sup>™</sup> K5 technology based on an innovative proprietary vertical structure. The result is a dramatic reduction in on-resistance and ultra-low gate charge for applications requiring superior power density and high efficiency.

#### AM15540v1

Table 1: Device summary				
Order code	Marking	Package	Packing	
STL7LN80K5	7LN80K5	PowerFLAT™ 5x6 VHV	Tape and reel	

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This is information on a product in full production.



PowerFLAT<sup>™</sup> 5x6 VHV

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### 1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
Vgs	Gate-source voltage	± 30	V
ID <sup>(1)</sup>	Drain current (continuous) at $T_c = 25 \ ^{\circ}C$	5	А
I <sub>D</sub> <sup>(1)</sup>	Drain current (continuous) at T <sub>c</sub> = 100 °C	3.4	А
ID <sup>(2)</sup>	Drain current (pulsed)	20	А
Ртот	Total dissipation at $T_C = 25 \ ^{\circ}C$	42	W
dv/dt <sup>(3)</sup>	Peak diode recovery voltage slope	4.5	V/ns
dv/dt <sup>(4)</sup>	MOSFET dv/dt ruggedness	50	v/ns
Tstg	Storage temperature range	55 to 150	°C
TJ	Operating junction temperature range	- 55 to 150	C

#### Notes:

<sup>(1)</sup>Limited by maximum junction temperature.

 $^{(2)}\mbox{Pulse}$  width limited by safe operating area.

 $^{(3)}I_{SD} \leq 5$  A, di/dt 100 A/µs; VDs peak < V(BR)DSS,VDD= 640 V.

 $^{(4)}V_{DS} \le 640 \text{ V}.$ 

#### Table 3: Thermal data

Symbol	Parameter	Value	Unit
Rthj-case	Thermal resistance junction-case	3	°C/W
R <sub>thj-pcb</sub> <sup>(1)</sup>	Thermal resistance junction-pcb	59	°C/W

#### Notes:

 $^{(1)}$  When mounted on 1inch² FR-4 board, 2 oz Cu.

#### Table 4: Avalanche characteristics

Symbol	Parameter	Value	Unit
I <sub>AR</sub>	Avalanche current, repetitive or not repetitive (pulse width limited by T <sub>jmax</sub> )	1.5	А
Eas	Single pulse avalanche energy (starting Tj = 25 °C, $I_D = I_{AR}$ , $V_{DD} = 50$ V)	200	mJ



#### 2 **Electrical characteristics**

 $T_C = 25$  °C unless otherwise specified

Table 5: On/off states						
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage	$V_{GS} = 0 V, I_D = 1 mA$	800			V
	Zara gata valtaga drain	$V_{GS} = 0 V, V_{DS} = 800 V$			1	μA
IDSS Zero gate voltage drain current	$V_{GS} = 0 \text{ V}, V_{DS} = 800 \text{ V},$ $T_{C} = 125 \text{ °C} (1)$			50	μA	
I <sub>GSS</sub>	Gate-body leakage current	$V_{DS}$ = 0 V, $V_{GS}$ = ±20 V			±10	μA
$V_{\text{GS(th)}}$	Gate threshold voltage	$V_{DS} = V_{GS}$ , $I_D = 100 \ \mu A$	3	4	5	V
RDS(on)	Static drain-source on-resistance	$V_{GS}$ = 10 V, I <sub>D</sub> = 2.5 A		0.95	1.15	Ω

#### Notes:

<sup>(1)</sup>Defined by design, not subject to production test.

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		-	270	-	pF
Coss	Output capacitance	V <sub>DS</sub> = 100 V, f = 1 MHz,	-	22	-	pF
Crss	Reverse transfer capacitance	V <sub>GS</sub> = 0 V	-	0.5	-	pF
C <sub>o(er)</sub> <sup>(1)</sup>	Equivalent capacitance energy related	$V_{DS} = 0$ to 640 V. $V_{GS} = 0$ V	-	17	-	nC
Co(tr) <sup>(2)</sup>	Equivalent capacitance time related	$v_{\rm DS} = 0.0040$ V, $v_{\rm GS} = 0.0$	-	48	-	nC
R <sub>G</sub>	Intrinsic gate resistance	$f = 1 \text{ MHz}, I_D=0 \text{ A}$	-	7.5	-	Ω
Qg	Total gate charge	$V_{DD} = 640 \text{ V}, \text{ I}_{D} = 5 \text{ A}, \text{ V}_{GS} = 0$	-	12	-	nC
Qgs	Gate-source charge	to 10 V (see Figure 15: "Test circuit for gate charge	-	2.6	-	nC
Q <sub>gd</sub>	Gate-drain charge	behavior")	-	8.6	-	nC

#### Table 6: Dynamic

#### Notes:

 $^{(1)}$ Energy related is defined as a constant equivalent capacitance giving the same stored energy as Coss when VDs increases from 0 to 80% VDSS

 $^{(2)}\mbox{Time}$  related is defined as a constant equivalent capacitance giving the same stored energy as  $C_{\mbox{oss}}$  when  $V_{\mbox{Ds}}$ increases from 0 to 80% VDSS



#### Electrical characteristics

	Table 7: Switching times							
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit		
t <sub>d(on)</sub>	Turn-on delay time	V <sub>DD</sub> = 400 V, I <sub>D</sub> = 2.5 A	-	9.3	-	ns		
tr	Rise time	$R_G = 4.7 \Omega$ , $V_{GS} = 10 V$ (see Figure 14: "Test circuit for	-	6.7	-	ns		
t <sub>d(off)</sub>	Turn-off-delay time	resistive load switching times"	-	23.6	-	ns		
t <sub>f</sub>	Fall time	and Figure 19: "Switching time waveform")	-	17.4	-	ns		

#### Table 8: Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Isd	Source-drain current		-		5	А
Isdm <sup>(1)</sup>	Source-drain current (pulsed)		-		20	А
Vsd <sup>(2)</sup>	Forward on voltage	$I_{SD}$ = 5 A, $V_{GS}$ = 0 V	-		1.6	V
trr	Reverse recovery time	I <sub>SD</sub> = 5 A, di/dt = 100 A/µs,	-	276		ns
Qrr	Reverse recovery charge	V <sub>DD</sub> = 60 V (see Figure 16: "Test circuit for	-	2.13		μC
I <sub>RRM</sub>	Reverse recovery current	inductive load switching and diode recovery times")	-	15.4		А
t <sub>rr</sub>	Reverse recovery time	I <sub>SD</sub> = 5 A, di/dt = 100 A/µs,	-	402		ns
Qrr	Reverse recovery charge	$V_{DD} = 60 \text{ V}, \text{ T}_{\text{j}} = 150 ^{\circ}\text{C}$ (see Figure 16: "Test circuit for	-	2.79		μC
I <sub>RRM</sub>	Reverse recovery current	inductive load switching and diode recovery times")	-	13.9		A

#### Notes:

<sup>(1)</sup>Pulse width is limited by safe operating area

 $^{(2)}$ Pulsed: pulse duration = 300 µs, duty cycle 1.5%

#### Table 9: Gate-source Zener diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)</sub> GSO	Gate-source breakdown voltage	$I_{GS} = \pm 1 \text{ mA}, I_D = 0 \text{ A}$	30	-		V

The built-in back-to-back Zener diodes are specifically designed to enhance the ESD performance of the device. The Zener voltage facilitates efficient and cost-effective device integrity protection, thus eliminating the need for additional external componentry.



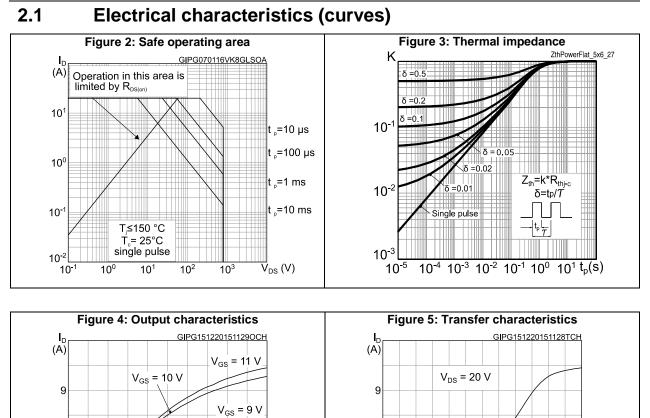
6

3

0

8

12



6

3

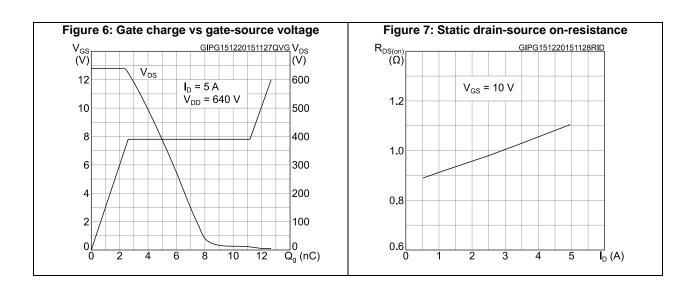
0L

6

8

9

10



V<sub>GS</sub> = 8 V

 $V_{GS} = 7 V$  $V_{GS} = 6 V$ 

V<sub>DS</sub> (V)

16

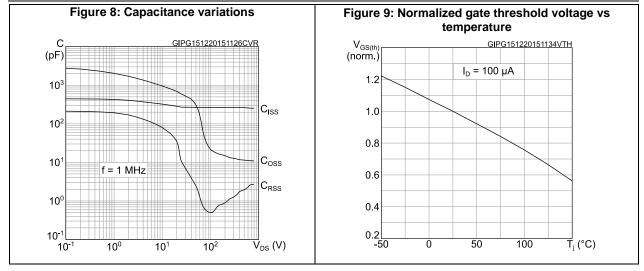
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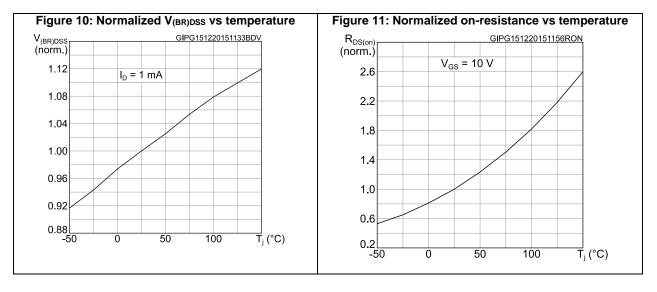


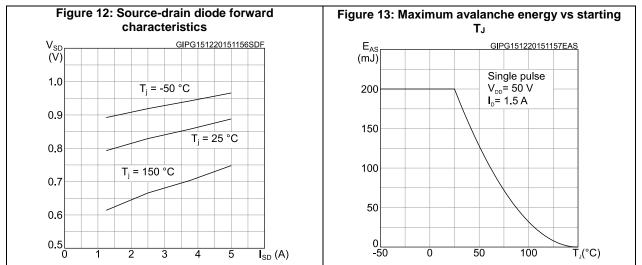
 $\overline{V}_{GS}(V)$ 

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#### **Electrical characteristics**

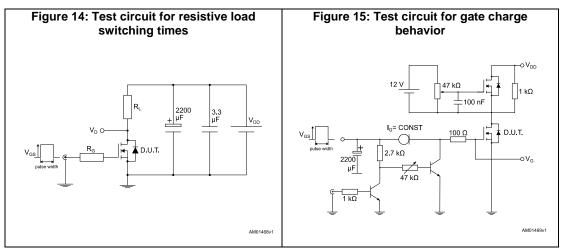


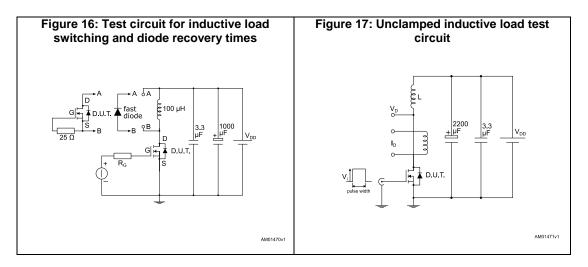


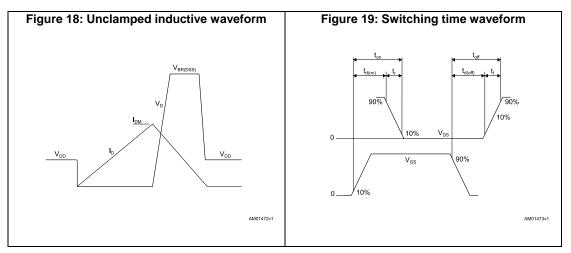


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### 3 Test circuits





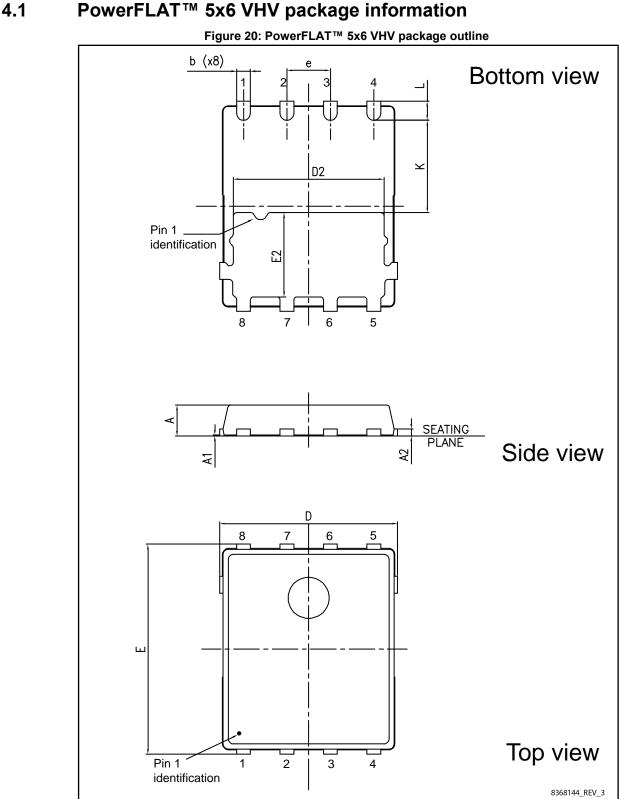


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### 4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK<sup>®</sup> is an ST trademark.





PowerFLAT<sup>™</sup> 5x6 VHV package information

#### STL7LN80K5

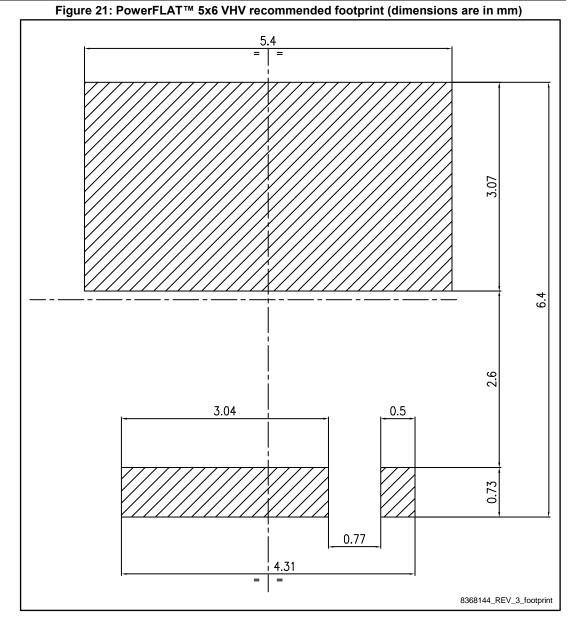
Package information

IK5	Package Information				
Tabl	le 10: PowerFLAT™ 5x6 \	/HV package mechanica	al data		
Dim.		mm			
Dini.	Min.	Тур.	Max.		
А	0.80		1.00		
A1	0.02		0.05		
A2		0.25			
b	0.30		0.50		
D	5.00	5.20	5.40		
E	5.95	6.15	6.35		
D2	4.30	4.40	4.50		
E2	2.40	2.50	2.60		
е		1.27			
L	0.50	0.55	0.60		
К	2.60	2.70	2.80		



#### Package information

#### STL7LN80K5



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#### 4.2 Powe

## PowerFLAT™ 5x6 packing information

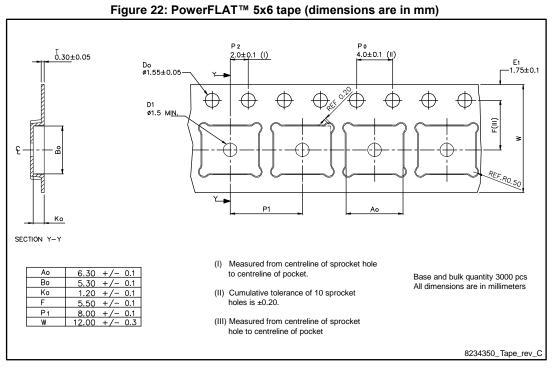
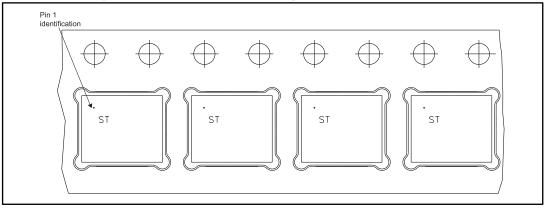


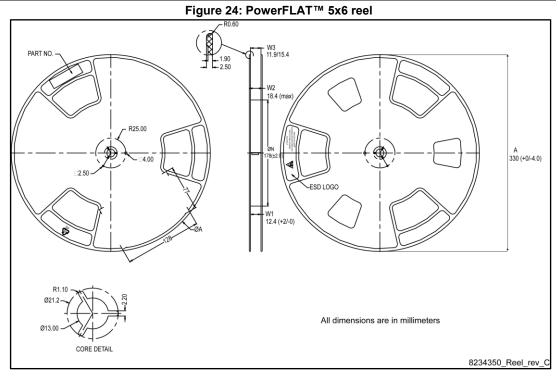
Figure 23: PowerFLAT™ 5x6 package orientation in carrier tape





#### Package information

#### STL7LN80K5





### 5 Revision history

Table 11: Document revision history

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Date	Revision	Changes
07-Jan-2016	1	First release.
26-Jan-2016	2	Modified: <i>Table 2: "Absolute maximum ratings"</i> Minor text changes
24-Apr-2017	3	Updated silhouette on cover page. Updated Section 4.1: "PowerFLAT™ 5x6 VHV package information". Minor text changes.



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